

Vishay Siliconix

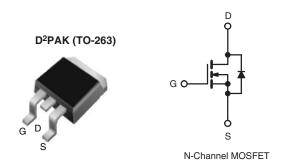
RoHS'

COMPLIANT

HALOGEN **FREE** 

### Power MOSFET

| PRODUCT SUMMARY            |                         |       |  |  |
|----------------------------|-------------------------|-------|--|--|
| V <sub>DS</sub> (V)        | 60                      |       |  |  |
| $R_{DS(on)}(\Omega)$       | V <sub>GS</sub> = 5.0 V | 0.028 |  |  |
| Q <sub>g</sub> (Max.) (nC) | 66                      |       |  |  |
| Q <sub>gs</sub> (nC)       | 12                      |       |  |  |
| Q <sub>gd</sub> (nC)       | 43                      |       |  |  |
| Configuration              | Single                  |       |  |  |



#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 **Definition**
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Logic-Level Gate Drive
- R<sub>DS(on)</sub> Specified at V<sub>GS</sub> = 4 V and 5 V
  175 °C Operating Temperature
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC



Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D<sup>2</sup>PAK (TO-263) is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D<sup>2</sup>PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

| ORDERING INFORMATION            |                             |                             |  |  |  |
|---------------------------------|-----------------------------|-----------------------------|--|--|--|
| Package                         | D <sup>2</sup> PAK (TO-263) | D <sup>2</sup> PAK (TO-263) |  |  |  |
| Lead (Pb)-free and Halogen-free | SiHLZ44S-GE3                | SiHLZ44STRR-GE3a            |  |  |  |
| Lead (Pb)-free                  | IRLZ44SPbF                  | IRLZ44STRRPbFa              |  |  |  |
|                                 | SiHLZ44S-E3                 | SiHLZ44STR-E3 <sup>a</sup>  |  |  |  |

#### Note

a. See device orientation.

| ABSOLUTE MAXIMUM RATINGS (TC                     | = 25 °C, unl                                     | ess otherwis  | se noted)       |                  |       |
|--|--|---|-----------------|------------------|-------|
| PARAMETER  |  | SYMBOL  | LIMIT           | UNIT             |       |
| Drain-Source Voltage                             |  | $V_{DS}$  | 60              | V                |       |
| Gate-Source Voltage                              |  |   | $V_{GS}$        | ± 10             | 7 V   |
| Continuous Drain Current <sup>f</sup>            | V at 5.0 V                                       | $T_{\rm C} = 25  ^{\circ}{\rm C}$<br>$T_{\rm C} = 100  ^{\circ}{\rm C}$ | 1               | 50               |       |
| Continuous Drain Current                         | V <sub>GS</sub> at 5.0 V                         | T <sub>C</sub> = 100 °C   | ID              | 36               | Α     |
| Pulsed Drain Current <sup>a</sup>                |  | I <sub>DM</sub>   | 200             |                  |       |
| Linear Derating Factor                           |  |   |                 | 1.0              | W/°C  |
| Linear Derating Factor (PCB Mount)e              |  |   |                 | 0.025            | VV/°C |
| Single Pulse Avalanche Energy <sup>b</sup>       |  |   | E <sub>AS</sub> | 400              | mJ    |
| Maximum Power Dissipation                        | T <sub>C</sub> = 25 °C<br>T <sub>A</sub> = 25 °C |   | р               | 150              | 14/   |
| Maximum Power Dissipation (PCB Mount)e           |  |   | P <sub>D</sub>  | 3.7              | W     |
| Peak Diode Recovery dV/dtc                       |  | dV/dt   | 4.5             | V/ns             |       |
| Operating Junction and Storage Temperature Range |  | T <sub>J</sub> , T <sub>stq</sub> - 55 to + 175                         |                 | °C               |       |
| Soldering Recommendations (Peak Temperature)d    | for  | 10 s  |                 | 300 <sup>d</sup> | 7     |

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 179  $\mu$ H,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 51 A (see fig. 12). c.  $I_{SD}$  < 51 A, dI/dt < 250 A/ $\mu$ s,  $V_{DD}$  <  $V_{DS}$ ,  $T_J$  < 175 °C.
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).
- f. Current limited by the package, (die current = 51 A).

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRLZ44S, SiHLZ44S

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| THERMAL RESISTANCE RATINGS                           |                   |      |      |      |  |
|--|-------------------|------|------|------|--|
| PARAMETER  | SYMBOL            | TYP. | MAX. | UNIT |  |
| Maximum Junction-to-Ambient                          | R <sub>thJA</sub> | -    | 62   |      |  |
| Maximum Junction-to-Ambient (PCB Mount) <sup>a</sup> | R <sub>thJA</sub> | -    | 40   | °C/W |  |
| Maximum Junction-to-Case (Drain)                     | R <sub>thJC</sub> | -    | 1.0  |      |  |

#### Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

| <b>SPECIFICATIONS</b> ( $T_J = 25  ^{\circ}\text{C}$ , $t$ | ınless otherw         | rise noted)   |  |           |                      |                  |       |
|--|-----------------------|---|--|-----------|----------------------|------------------|-------|
| PARAMETER  | SYMBOL                | TES   | TEST CONDITIONS  |           | TYP.                 | MAX.             | UNIT  |
| Static   |                       |   |  | •         |                      |                  |       |
| Drain-Source Breakdown Voltage                             | V <sub>DS</sub>       | V <sub>GS</sub>   | 60   | -         | -                    | V                |       |
| V <sub>DS</sub> Temperature Coefficient                    | $\Delta V_{DS}/T_{J}$ | Reference   | ce to 25 °C, I <sub>D</sub> = 1 mA                                       | -         | 0.070                | -                | V/°C  |
| Gate-Source Threshold Voltage                              | V <sub>GS(th)</sub>   | V <sub>DS</sub> =   | = V <sub>GS</sub> , I <sub>D</sub> = 250 μA                              | 1.0       | -                    | 2.0              | V     |
| Gate-Source Leakage  | I <sub>GSS</sub>      | V <sub>GS</sub> = ± 10 V  |  | -         | -                    | ± 100            | nA    |
| Zoro Coto Voltago Drain Current                            |                       | V <sub>DS</sub> :   | V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V                            |           | -                    | 25               |       |
| Zero Gate Voltage Drain Current                            | I <sub>DSS</sub>      | V <sub>DS</sub> = 48 V  | , V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C                         | -         | -                    | 250              | μA    |
| Drain Course On State Desigtance                           | Б                     | V <sub>GS</sub> = 5.0 V   | I <sub>D</sub> = 31 A <sup>b</sup>                                       | -         | -                    | 0.028            | Ω     |
| Drain-Source On-State Resistance                           | R <sub>DS(on)</sub>   | V <sub>GS</sub> = 4.0 V   | I <sub>D</sub> = 25 A <sup>b</sup>                                       | -         | -                    | 0.039            |       |
| Forward Transconductance                                   | 9 <sub>fs</sub>       | V <sub>DS</sub> :   | = 25 V, I <sub>D</sub> = 31 A <sup>b</sup>                               | 23        | -                    | -                | S     |
| Dynamic  |                       |   |  |           |                      |                  |       |
| Input Capacitance  | C <sub>iss</sub>      |   | $V_{GS} = 0 V$ ,   | -         | 3300                 | -                |       |
| Output Capacitance   | C <sub>oss</sub>      |   | $V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ f = 1.0 MHz, see fig. 5 |           | 1200                 | -                | pF    |
| Reverse Transfer Capacitance                               | C <sub>rss</sub>      | ] f = 1.  |  |           | 200                  | -                |       |
| Total Gate Charge  | Qg                    |   |  | -         | -                    | 66               | nC    |
| Gate-Source Charge   | $Q_{gs}$              | $V_{GS} = 5.0 \text{ V}$  | $I_D = 51 \text{ A}, V_{DS} = 48 \text{ V},$<br>see fig. 6 and $13^b$    | -         | -                    | 12               |       |
| Gate-Drain Charge  | $Q_{gd}$              |   | ooo ng. o ana ro   | -         | -                    | 43               |       |
| Turn-On Delay Time   | t <sub>d(on)</sub>    |   |  | -         | 17                   | -                |       |
| Rise Time  | t <sub>r</sub>        | $V_{DD}=30$ V, $I_{D}=51$ A, $R_{g}=4.6$ $\Omega$ , $R_{D}=0.56$ $\Omega$ , see fig. $10^{b}$ |  | -         | 230                  | -                | ns ns |
| Turn-Off Delay Time  | t <sub>d(off)</sub>   |   |  | -         | 42                   | -                |       |
| Fall Time  | t <sub>f</sub>        |   |  |           | 110                  | -                |       |
| Internal Drain Inductance                                  | L <sub>D</sub>        |   | Between lead,<br>6 mm (0.25") from                                       |           | 4.5                  | -                | ъЦ    |
| Internal Source Inductance                                 | L <sub>S</sub>        | package and center of die contact   |  | -         | 7.5                  | -                | - nH  |
| Drain-Source Body Diode Characteristic                     | cs                    |   |  |           |                      |                  |       |
| Continuous Source-Drain Diode Current                      | I <sub>S</sub>        | MOSFET symbol showing the integral reverse p - n junction diode                               |  | -         | -                    | 50°              | A     |
| Pulsed Diode Forward Current <sup>a</sup>                  | I <sub>SM</sub>       |   |  | -         | -                    | 200              | _ ^   |
| Body Diode Voltage   | $V_{SD}$              | T <sub>J</sub> = 25 °C, I <sub>S</sub> = 51 A, V <sub>GS</sub> = 0 V <sup>b</sup>             |  | -         | -                    | 2.5              | V     |
| Body Diode Reverse Recovery Time                           | t <sub>rr</sub>       | T - 25 °C 1   | - 51 A dl/d+ - 100 A/:-ah  | -         | 130                  | 180              | ns    |
| Body Diode Reverse Recovery Charge                         | Q <sub>rr</sub>       | $T_J = 25 ^{\circ}\text{C}, I_F = 51 \text{A}, dI/dt = 100 \text{A/}\mu\text{s}^b$            |  | -         | 0.84                 | 1.3              | μC    |
| Forward Turn-On Time                                       | t <sub>on</sub>       | Intrinsic tu  | -on is dor   | minated b | y L <sub>S</sub> and | L <sub>D</sub> ) |       |

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
  b. Pulse width ≤ 300 μs; duty cycle ≤ 2 %.
  c. Current limited by the package, (Die Current = 51 A).



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

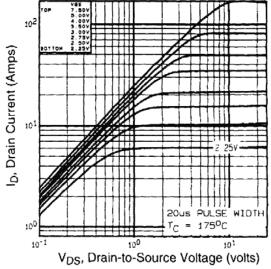


Fig. 2 - Typical Output Characteristics,  $T_C$  = 150 °C

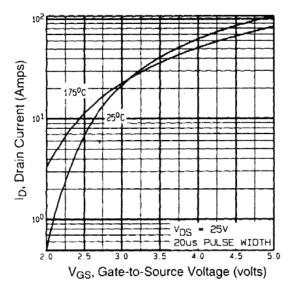


Fig. 3 - Typical Transfer Characteristics

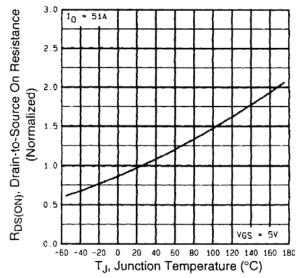


Fig. 4 - Normalized On-Resistance vs. Temperature

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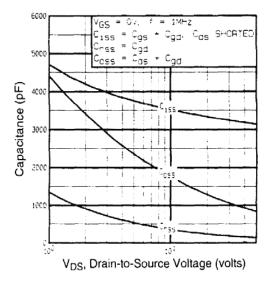


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

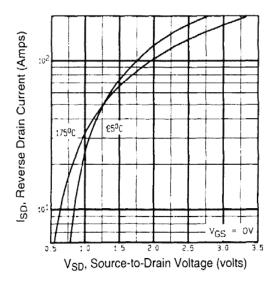


Fig. 7 - Typical Source-Drain Diode Forward Voltage

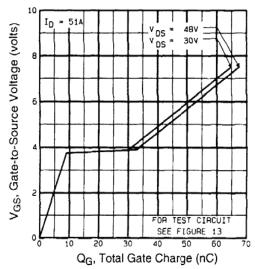


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

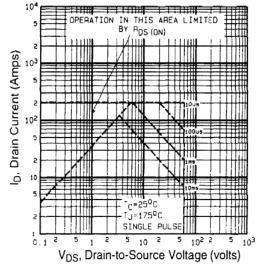
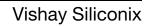


Fig. 8 - Maximum Safe Operating Area





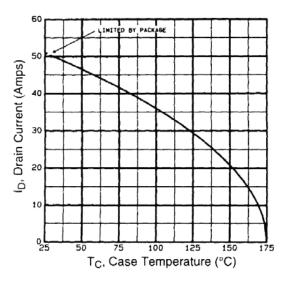


Fig. 9 - Maximum Drain Current vs. Case Temperature

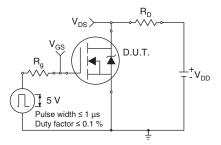


Fig. 10a - Switching Time Test Circuit



Fig. 10b - Switching Time Waveforms

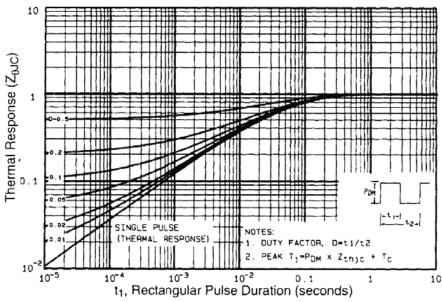
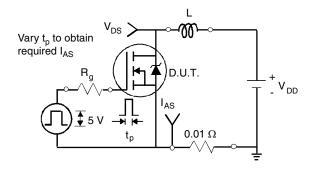


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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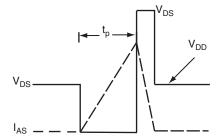


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

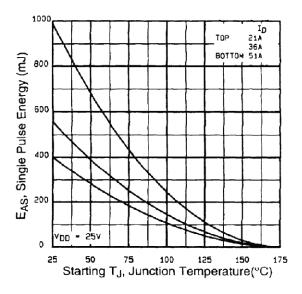


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

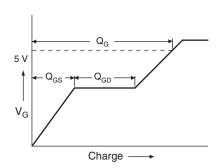


Fig. 13a - Basic Gate Charge Waveform

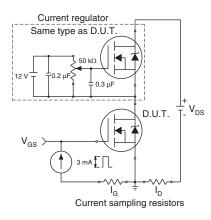
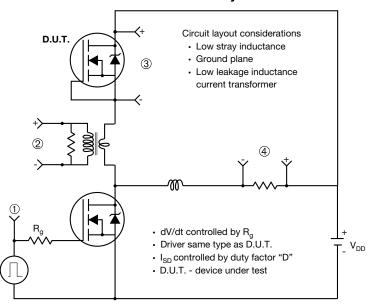


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



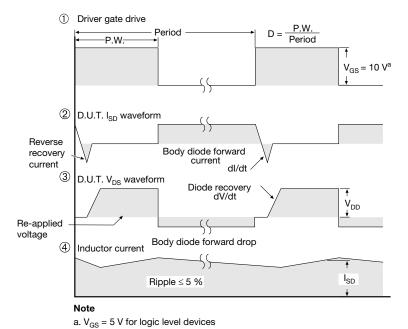


Fig. 14 - For N-Channel

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